



Product Discontinuation Notice: Discontinuance of Die and Wafer Sales for All Xilinx Product Families - Retraction

PDN99004 (v2.0) November 2, 2012

Product Discontinuation Notice

Overview

The purpose of this notification is to communicate Xilinx is “retracting” PDN99004 due to customer demand.

Description

All previous communication on bare die business closure is no longer valid.

Products Affected

Applicable bare die and wafer sales for all Xilinx product families.

Key Dates and Ordering Information

N/A

Response

Customers are requested to contact their Xilinx Sales Representative for new life cycle information.

Important Notice: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<http://www.xilinx.com/support>). Register today and personalize your “Documentation and Design Advisory Alerts” area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to Answer Record 18683: <http://www.xilinx.com/support/answers/18683.htm>.

Revision History

The following table shows the revision history for this document:

Date	Version	Description of Revisions
07/01/1999	1.0	Initial release.
11/02/2012	2.0	PDN Retracted.

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